



Improving NAND Performance Using Upcoming Features

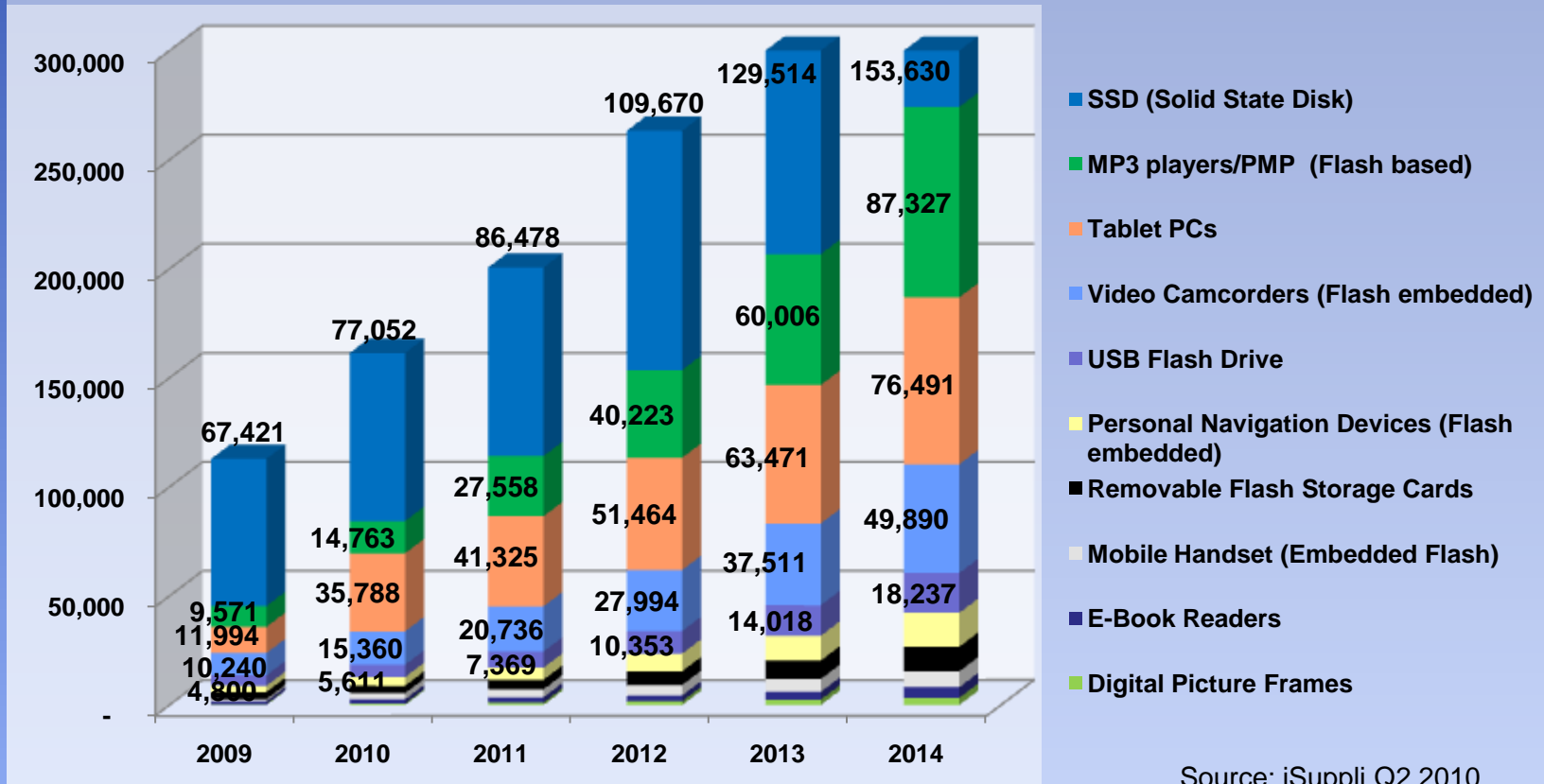
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Overview

- NAND market and trends
- Hurdles for performance
- Overcoming the hurdles
- Conclusion

NAND Market: High-Density Apps

Megabytes per Unit – Top 10 Density Applications
(Clamped at 300K)



Source: iSuppli Q2 2010

NAND Trends

Density-hungry applications drive NAND trends

- Rapidly shrinking process technology
- Architecture - increasing NAND block sizes



Source: micron.com

8GB now available on single NAND MLC die!

Performance Hurdles

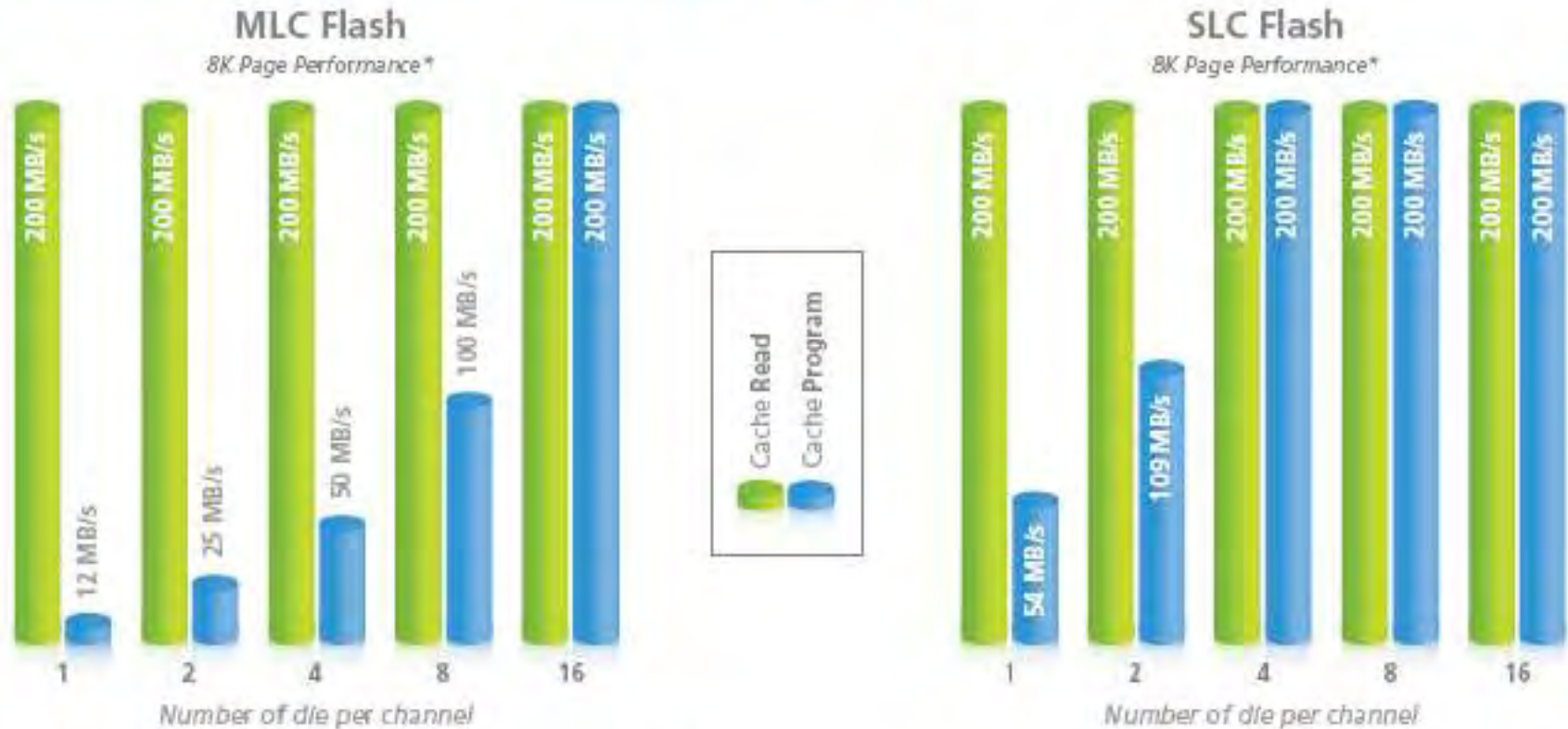
- The push for density results in:
 - Slower NAND array timings
 - Increase in ECC requirements
 - Longer block copy times
 - Lower program/erase endurance
- Density trends *reduce* NAND cost at the expense of performance and reliability

Overcoming the Hurdles

- Increase NAND interface speeds
 - ONFI 2.3 → 200 MB/sec
 - ONFI 3.0 → 400 MB/sec
- Issue simultaneous operations
 - Multi-plane operations
 - Interleaved operations via NAND scaling
- ECC solutions (EZ NAND)
 - Removes ECC system overhead

NAND Scaling and Interface

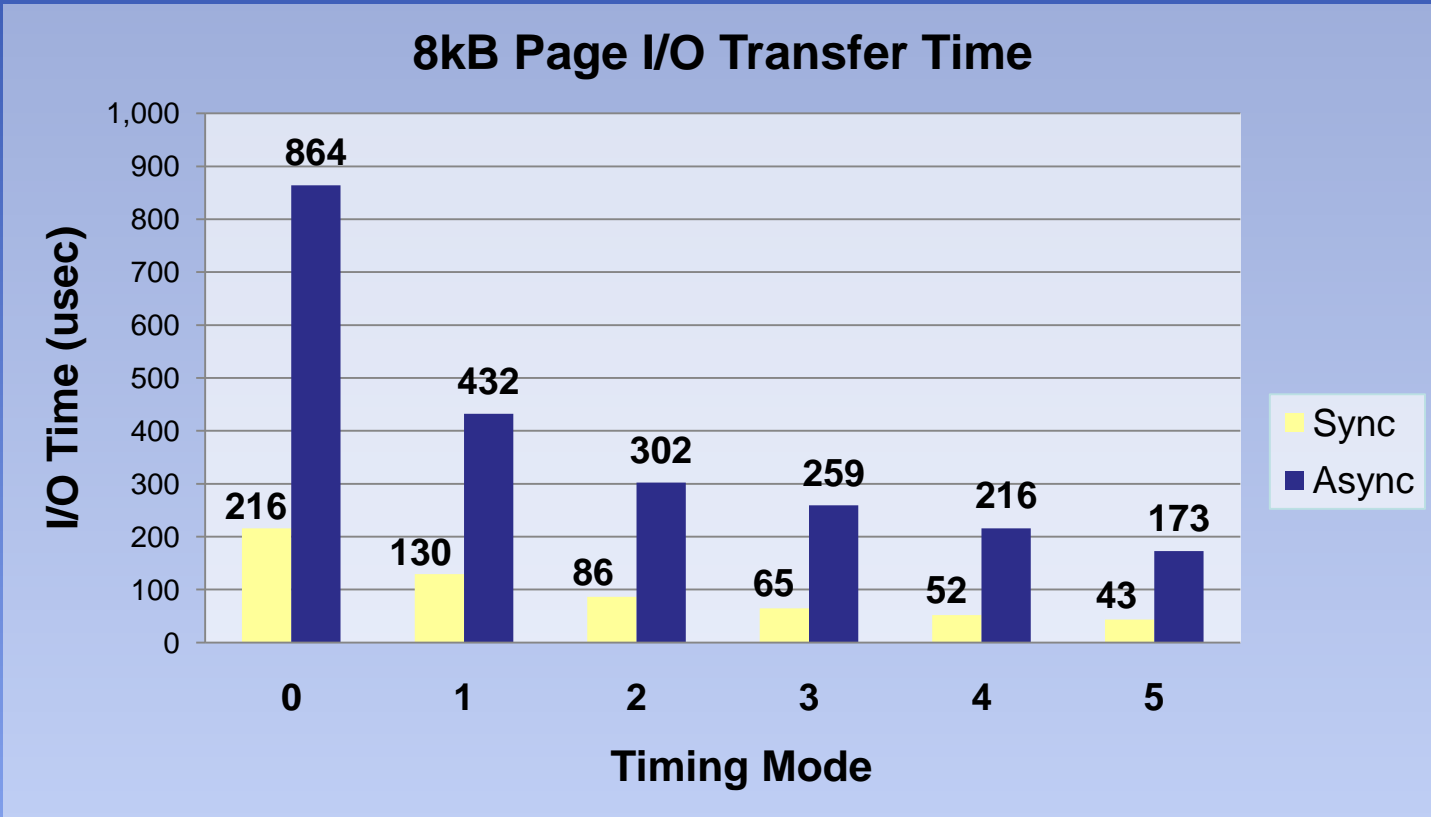
Commercially Available 25nm ONFI 2.X Sync DDR Flash



*Maximum sequential performance assuming no controller overhead.

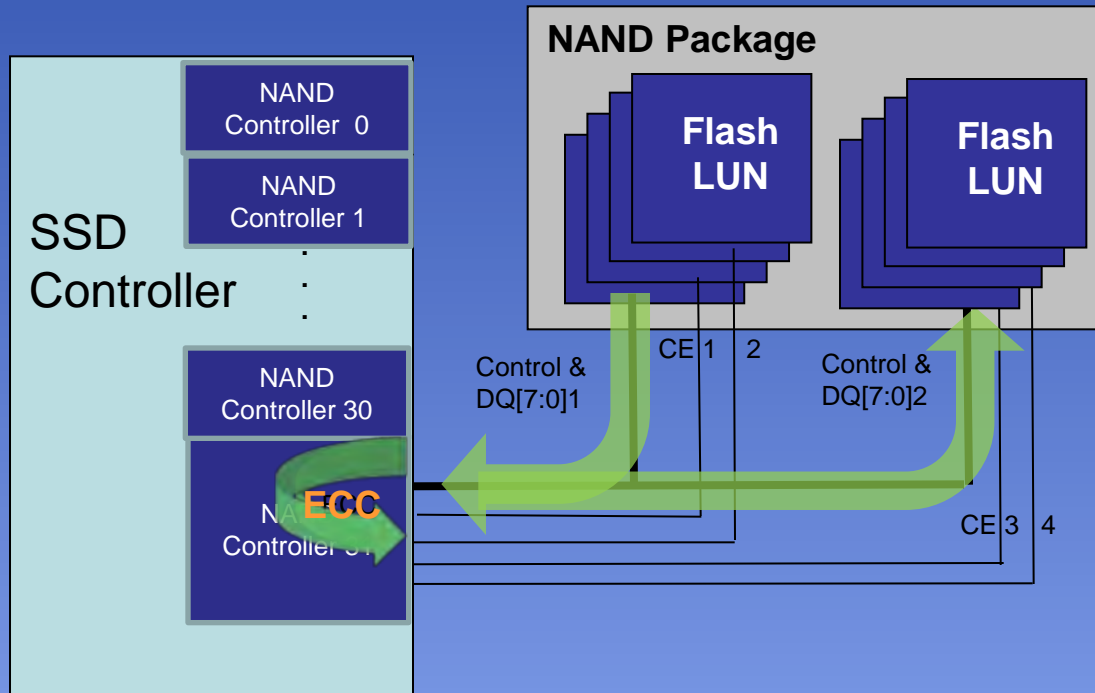
Source: onfi.org 08/10

Overcoming Performance Hurdles



Use fastest timing mode available (sync TM5)

Copyback Using Raw NAND

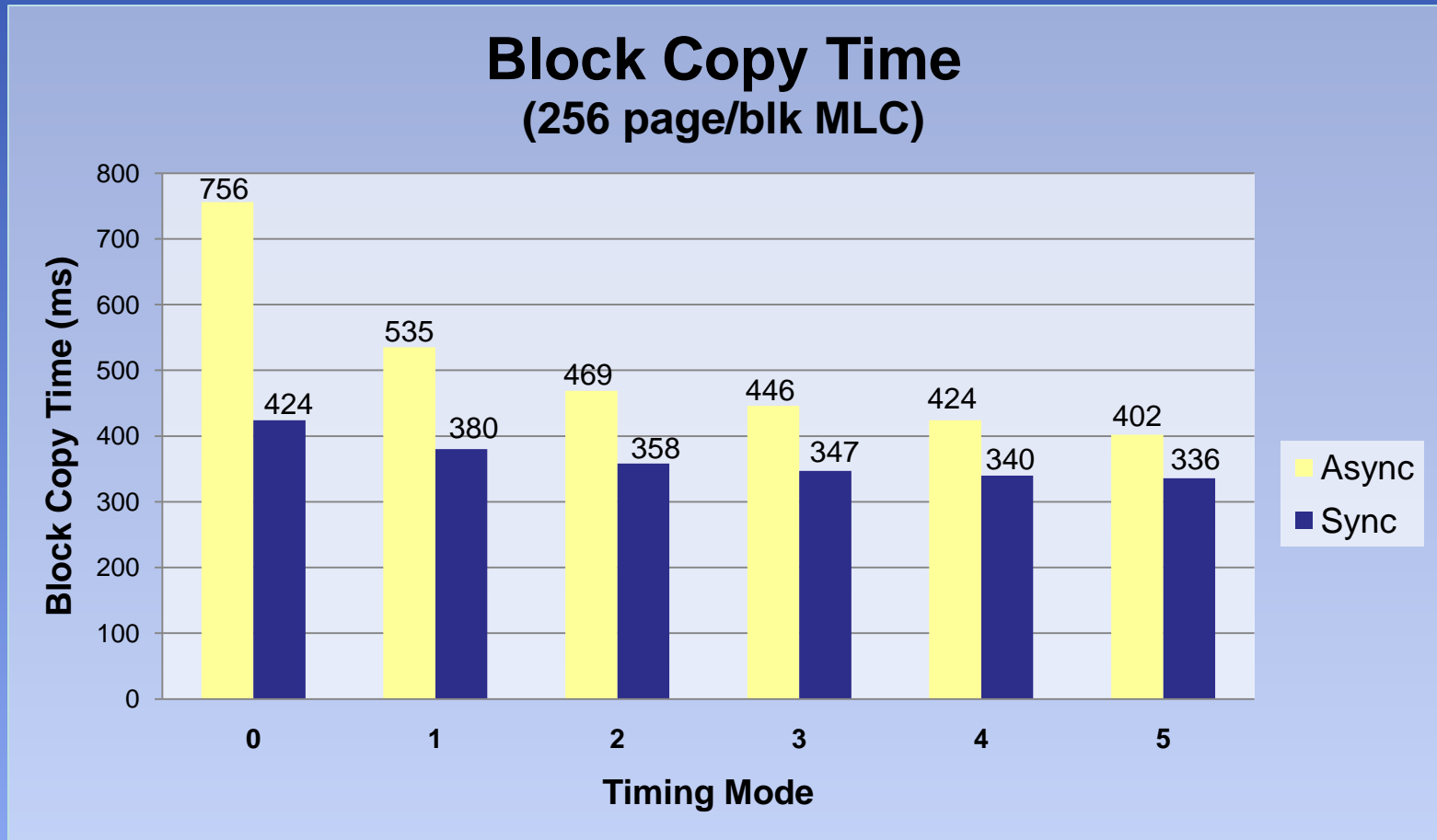


Copyback time = t_R + Read I/O + ECC time + PGM I/O + t_{PROG}

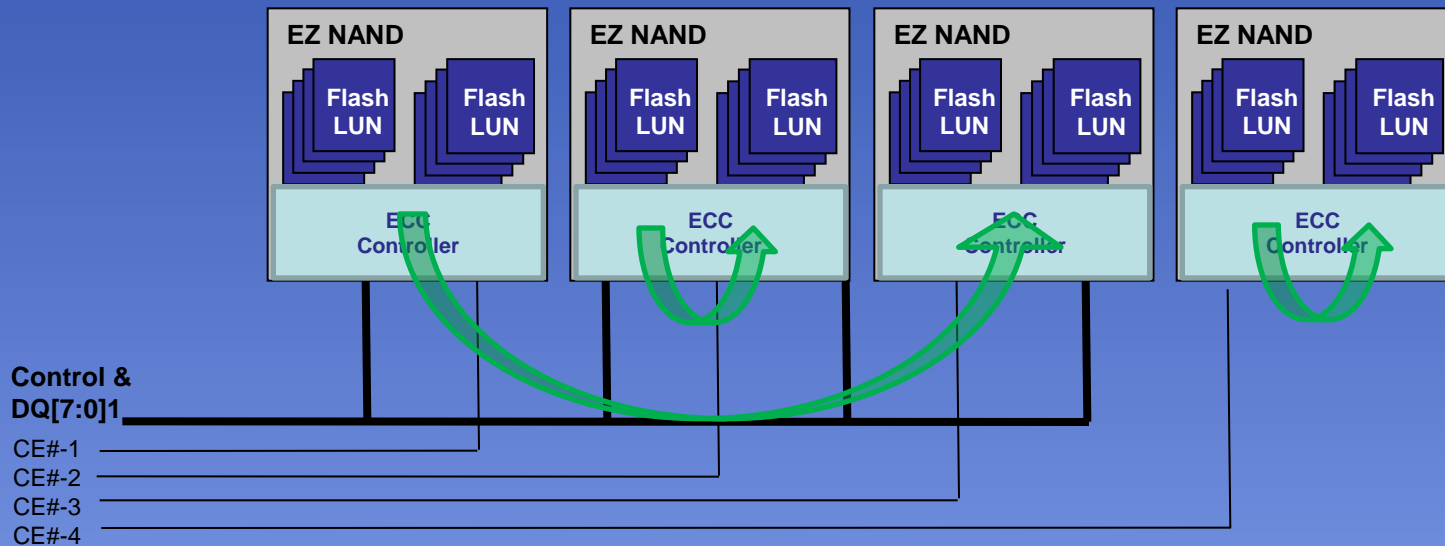
Sample BCH ECC overhead (83 MHz):

16-bit/512B	~74 μ s
32-bit /1kB	~186 μ s

Sample Copyback Performance



Copyback Using EZ NAND



- Copyback operation can be contained within the EZ NAND device
- Potential for simultaneous operations within each package

Conclusion

- NAND market is driving ***lowest cost***, highest density NAND
 - Results in challenges for NAND performance
- Must overcome NAND array challenges
 - Faster interface
 - NAND scaling
 - Improved NAND management

